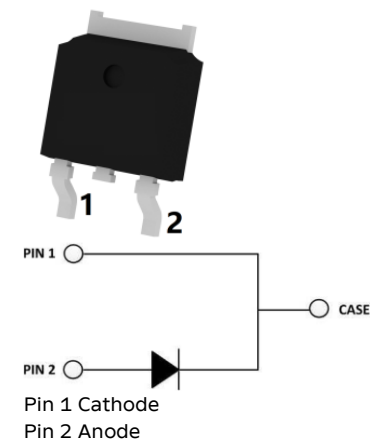


SCD015DA120S24F

5th Generation 1200V/15A SiC Schottky Barrier Diode

第五代 1200V/15A 碳化硅肖特基二极管

Package Type: TO-252-2L

 $V_{RRM} = 1200\text{ V}$ $I_F(135\text{ }^{\circ}\text{C}) = 20\text{ A}$ $V_F(25\text{ }^{\circ}\text{C}) = 1.40\text{ V}$

- High-speed switching performance
高速开关表现
- No reverse recovery
无反向恢复

Maximum ratings 最大额定值^{1 2}

PARAMETER 参数	SYMBOL 符号	CONDITIONS 条件	MIN 最小	MAX 最大	UNIT 单位
Repetitive peak reverse voltage 重复反向峰值电压	V_{RRM}	$T_{vj} = 25\text{ }^{\circ}\text{C}$		1200	V
Surge peak reverse voltage 浪涌峰值反向电压	V_{RSM}			1200	V
DC reverse voltage 直流反向电压	V_{DC}			1200	V
Continuous forward current 连续正向电流	I_F	$T_C = 25\text{ }^{\circ}\text{C}$		39	A
		$T_C = 135\text{ }^{\circ}\text{C}$		20	A
		$T_C = 150\text{ }^{\circ}\text{C}$		15	A
Surge non-repetitive forward current 非重复正向浪涌电流	I_{FSM}	$T_C = 25\text{ }^{\circ}\text{C}$, $t_p = 10\text{ ms}$, half sine pulse		155	A
Repetitive peak forward current 重复峰值正向电流	I_{FRM}	$T_C = 25\text{ }^{\circ}\text{C}$, $t_p = 10\text{ ms}$, half sine wave $D = 0.1$		75	A
Power dissipation 耗散功率	P_{tot}			200	W
i^2t value 安秒平方值	$\int i^2 dt$	$T_C = 25\text{ }^{\circ}\text{C}$, $t_p = 10\text{ ms}$		120	A^2s
Operation junction temperature 工作结温范围	T_{vj}		-55	175	$^{\circ}\text{C}$
Storage temperature 存储温度范围	T_{stg}		-55	175	$^{\circ}\text{C}$



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¹ Maximum rated values indicate limits beyond which damage to the device may occur per IEC 60747¹ 根据标准 IEC 60747 要求，最大额定值表示超过该限值可能会对器件造成损坏² $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified / 除非另有规定, $T_{vj} = 25\text{ }^{\circ}\text{C}$



SiC Diode^{3 4}

PARAMETER 参数	SYMBOL 符号	CONDITIONS 条件	MIN 最小	TYP 典型	MAX 最大	UNIT 单位
DC blocking voltage 直流击穿电压	V _{DC}	I _R = 100 µA	1200			V
Forward voltage 正向导通压降	V _F	I _F = 15 A		1.40	1.60	V
				2.00	2.40	V
Reverse current 反向电流	I _R	V _R = 1200 V		5	60	µA
				20	240	µA
Total capacitance 总电容	C	f = 1 MHz		1020		pF
				69		pF
				51		pF
Total capacitive charge 总电容电荷	Q _C	V _R = 800 V (∫C(V)dV)		73		nC
Capacitance stored energy 电容储存能量	E _C	V _R = 800 V (∫Q _C (V)dV)		21		µJ

Package properties 封装特性

PARAMETER 参数	SYMBOL 符号	CONDITIONS 条件	MIN 最小	TYP 典型	MAX 最大	UNIT 单位
Thermal resistance from junction to case 结到壳热阻	R _{th(j-c)}			0.75		K/W

³ Characteristic values according to IEC 60747-2 / 特性值依据 IEC 60747-2

⁴ T_{vj} = 25 °C, unless otherwise specified / 除非另有规定, T_{vj} = 25 °C

Characteristics 特性曲线

Figure 1. Forward characteristics

图 1. 正向特性

$I_F = f(V_F)$

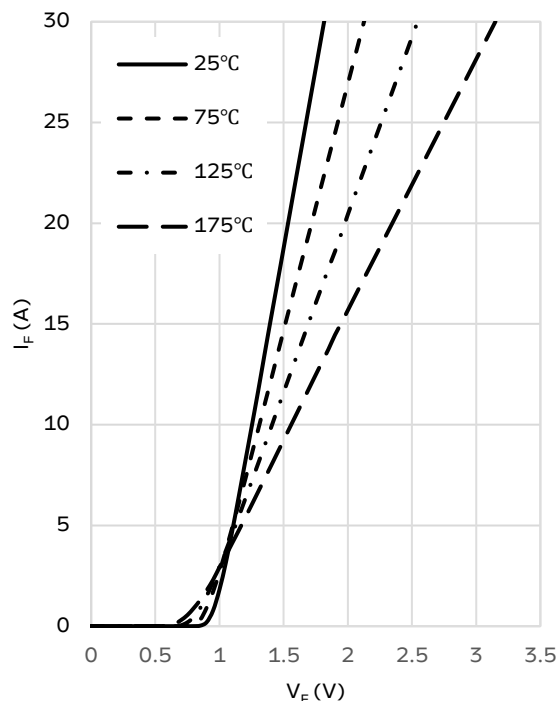


Figure 2. Reverse characteristics

图 2. 反向特性

$I_R = f(V_R)$

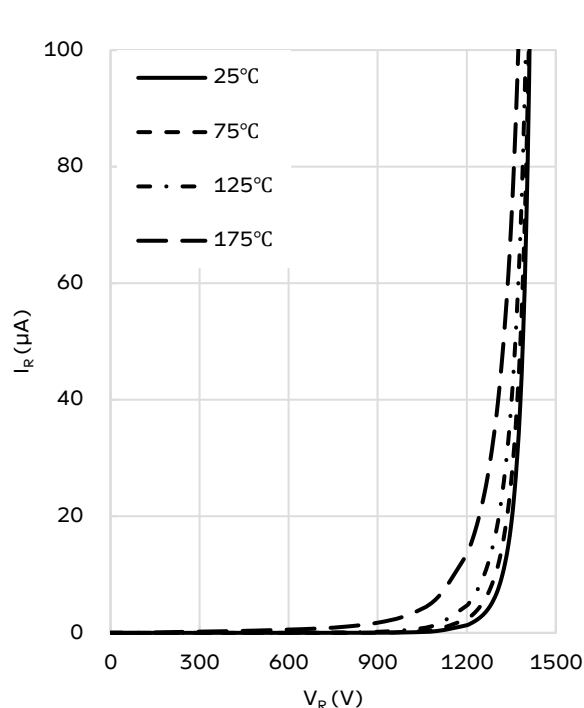


Figure 3. Current derating

图 3. 电流降额

$I_{F(\text{peak})} = f(T_C)$

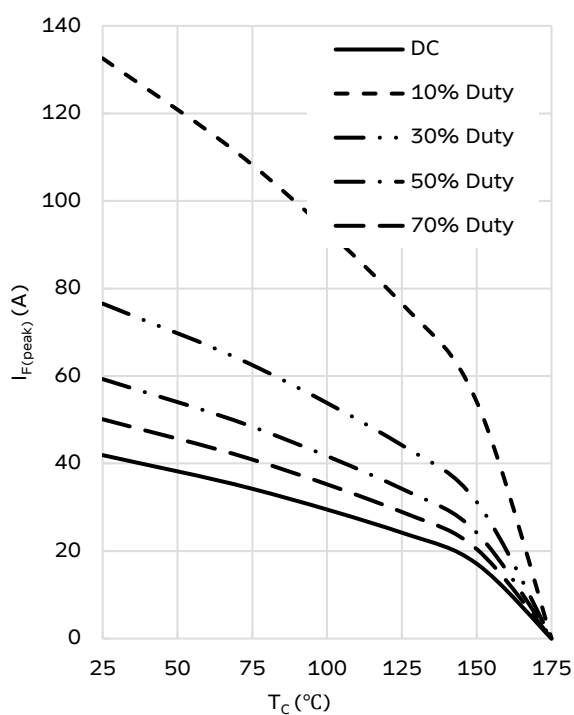


Figure 4. Power derating

图 4. 功率降额

$P_{\text{tot}} = f(T_C)$

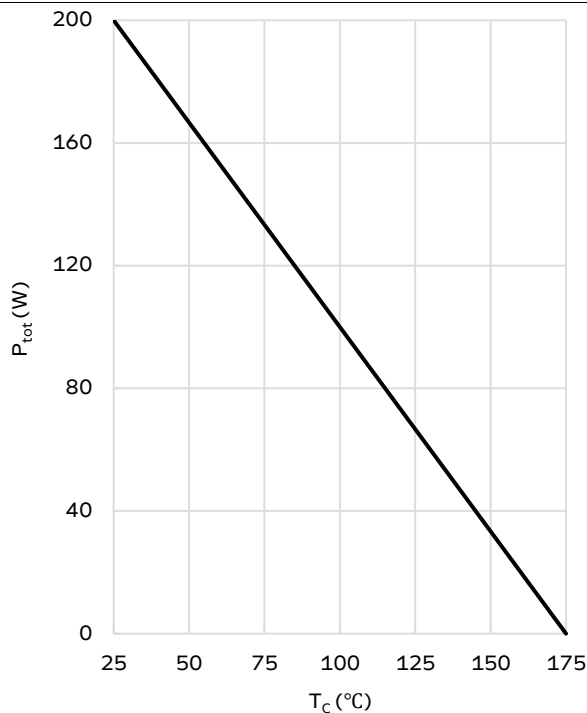




Figure 5. Capacitance vs. reverse voltage

图 5. 电容 vs 反向电压

$$C = f(V_R)$$

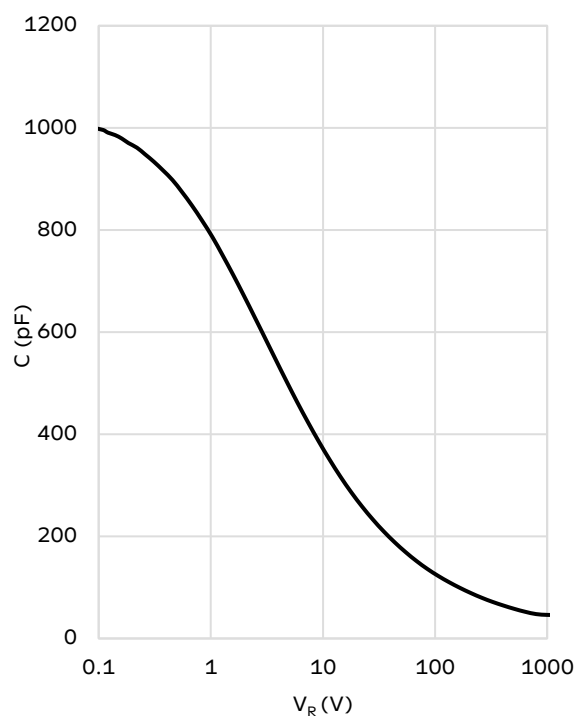


Figure 6. Total capacitance charge vs. reverse voltage

图 6. 总电容电荷 vs 反向电压

$$Q_C = f(V_R)$$

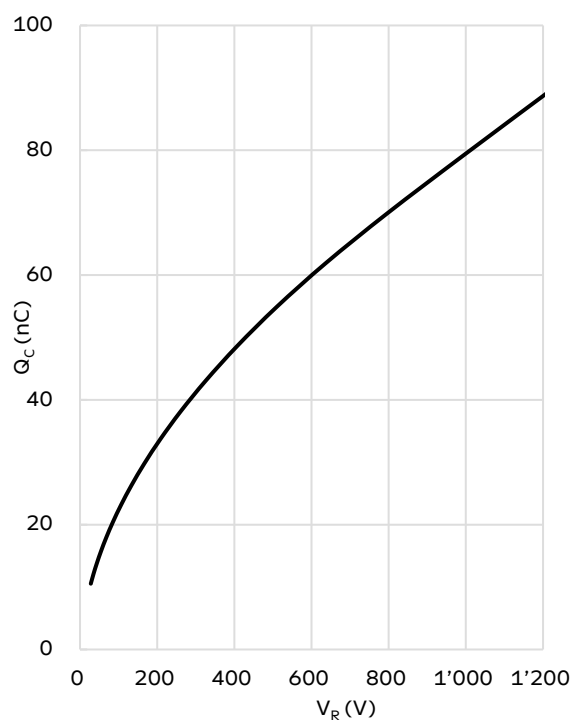


Figure 7. Capacitance stored energy

图 7. 电容储存能量

$$E_C = f(V_R)$$

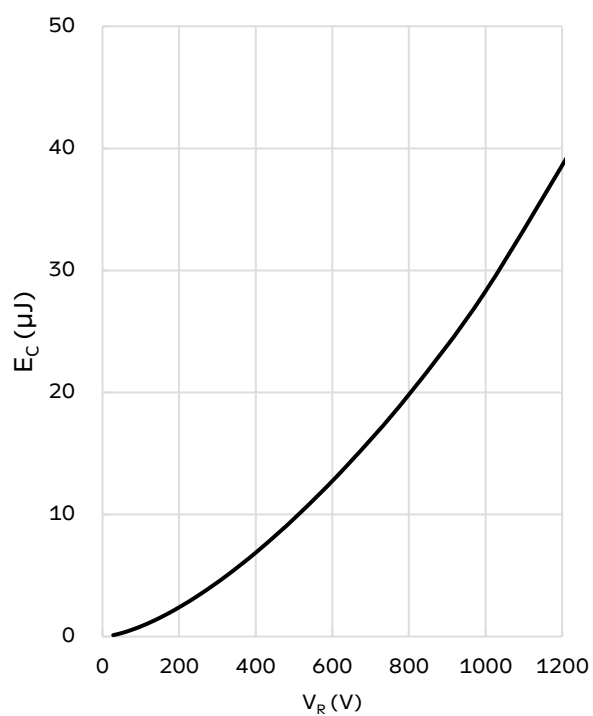
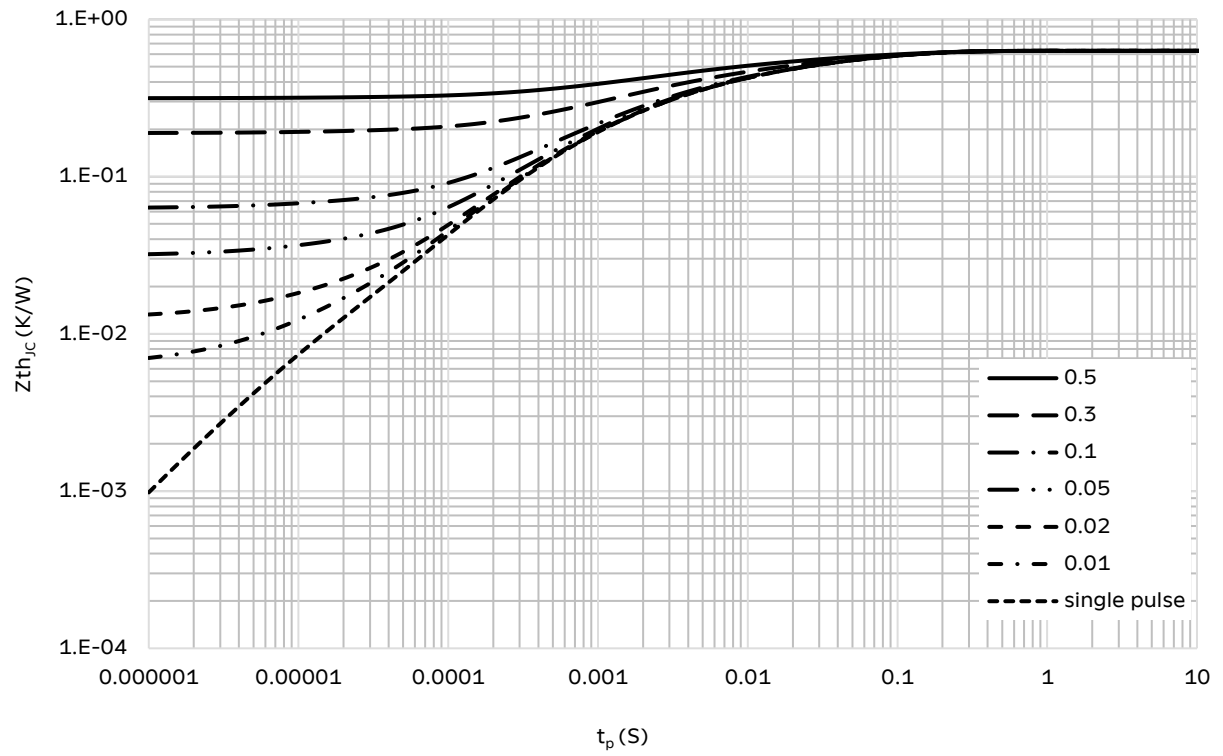




Figure 8. Transient thermal impedance (Junction - Case)

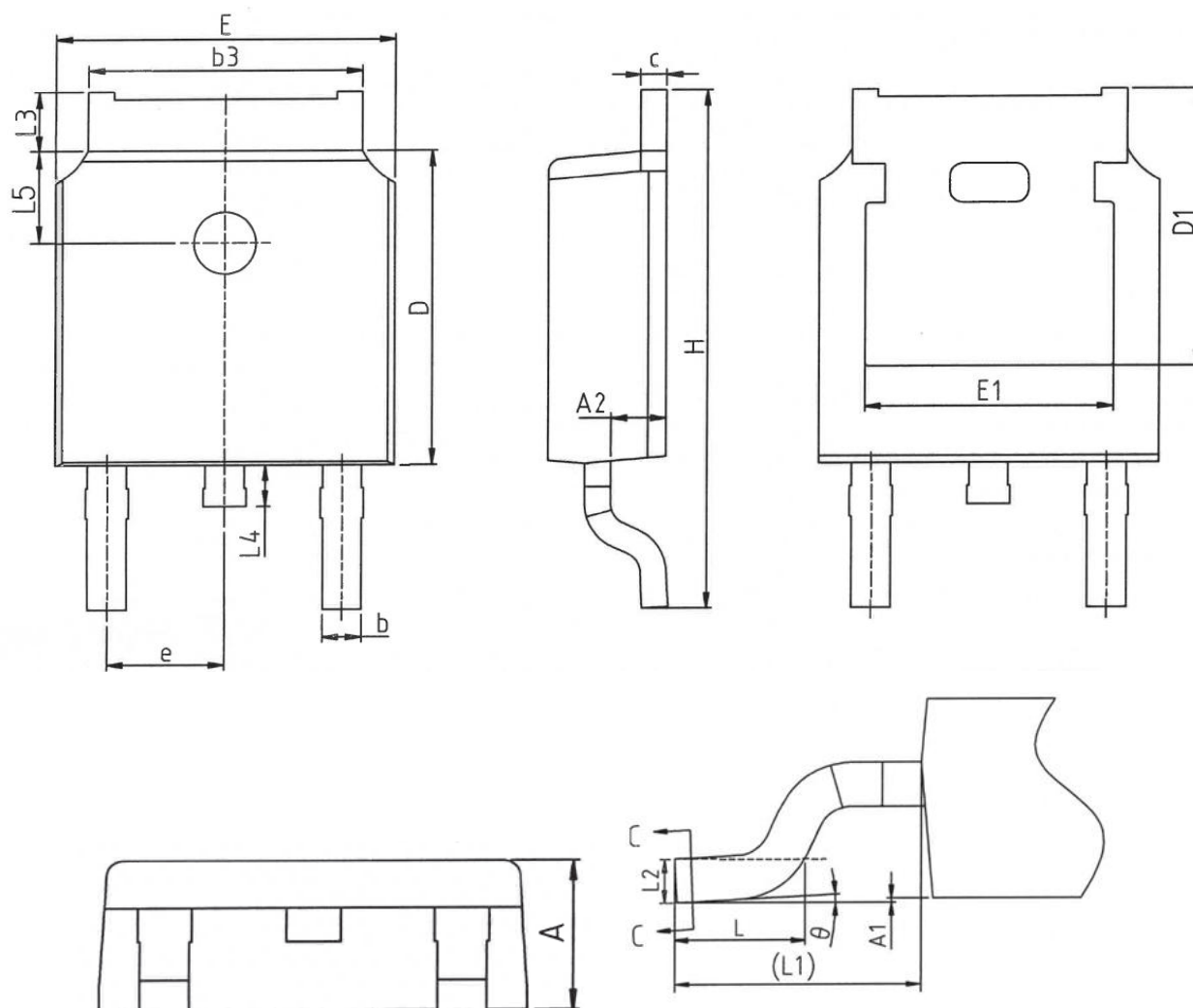
图 8. 瞬态热阻

$$Z_{th,jc} = f(t_p)$$



Outline drawing 外形图

Marking SCDS24F015DA120



Sym- bol	Dimensions In Mil- limeters	
	Min.	Max.
A	2.20	2.38
A1	0.00	0.12
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.46
c	0.43	0.61
D	5.98	6.22
D1	TYP 5.30	
E	6.40	6.73
E1	4.63	-

Sym- bol	Dimensions In Mil- limeters	
	Min.	Max.
e	2.286 BSC	
H	9.40	10.50
L	1.38	1.75
L1	TYP 2.90	
L2	0.51 BSC	
L3	0.88	1.28
L4	0.50	1.00
L5	1.65	1.95
θ	0°	8°

This is an electrostatic sensitive device. 本产品对静电特别敏感.

This product has been designed and qualified for Industrial Level. 本产品的设计符合工业级标准

Note: All dimensions are in mm



Ordering Information 订购信息

OPTION 选项		ARTICLE NUMBER 商品编号
Qualification grade	Industrial (F)	SCD015DA120S24F
Packaging Method 包装方式	Tape and reel (_P10)	SCD015DA120S24F _P10

Revision History 修订历史

Release 发布	Version 版本	Description 描述
2026-07-27	v1.0	Preliminary Datasheet 初始规格书